

## Statement of Compliance

#### **Requested Part**

| 14 December 2022   |  |   | (Part 1 of 1)  |  |  |  |
|--|--|---|--|--|--|--|
|  | TE Internal Number:                        | 205089-1  |  |  |  |  |
|  | Product Description:                       | HD 20 PIN CONTACT   |  |  |  |  |
|  | Part Status:                               | Active  |  |  |  |  |
|  | Mil-Spec Certified:                        | M39029/64-369   |  |  |  |  |
| EU RoH   | S Directive 2011/65/EU:                    | Compliant with Exemptions<br>6(c) - Pb-Alloy in Copper  |  |  |  |  |
| This declaration covers EU Directive 2011/65/EU incl. Delegated Directive 2015/863/EU. |  |   |  |  |  |  |
|  | EU ELV Directive:<br>2000/53/EC            | Compliant with Exemptions<br>3 - Lead in copper alloy containing u<br>weight.   | ıp to 4% lead by   |  |  |  |
|  | China RoHS:<br>MIIT Order No 32, 2016      | Restricted Materials Above Thr  | eshold   |  |  |  |
| EU RE/   | ACH SvHC Compliance:<br>(EC) No. 1907/2006 | Current ECHA Candidate List: JUNE<br>Candidate List Declared Against: JU<br>SVHC > Threshold:<br>Pb (1.5% in Component Part)<br>Article Safe Usage Statements:<br>Do not eat, drink or smoke when using this prod<br>handling. Recycle if possible and dispose of the<br>governmental regulations relevant to your geog | INE 2022 (224)<br>duct. Wash thoroughly after<br>e article by following all applicable |  |  |  |
|  | Halogen Content:                           | Low Halogen - Br, Cl, F, I < 900 ppn<br>material. Also BFR/CFR/PVC Free   | n per homogenous   |  |  |  |
| Solder P   | rocess Capability Code:                    | Not applicable for solder process ca  | pability   |  |  |  |
|  | Material Declarations:                     | MD_205089-1<br>MD_205089-1  |  |  |  |  |

**TE Connectivity Corporation** 

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This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change.

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked.

Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV).

Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

### Page 1 of 2



Restricted Materials Above Threshold

14 December 2022

50

#### 中国电子电气产品中有害物质的名称及含量

### China EEP Hazardous Substance Information

| 部件名称                           |                           |                           | 有                             | ī害物质          |         |        |
|--------------------------------|---------------------------|---------------------------|-------------------------------|---------------|---------|--------|
| (Component Name)               | Hazardous Substance       |                           |                               |               |         |        |
| 205089-1                       | 铅                         | 汞                         | 镉                             | 六价铬           | 多溴联苯    | 多溴二苯酚  |
|                                | (Pb)                      | (Hg)                      | (Cd)                          | (Cr6)         | (PBB)   | (PBDE) |
| 连接器系统                          | x                         | 0                         | 0                             | 0             | 0       | 0      |
| (Connector Systems)            |                           |                           |                               |               |         |        |
| 本表格依据SJ/T 1136<br>O: 表示该有害物质在i | 亥部件所有均质                   | 质材料中的含量                   | 齿在GB/T 265                    | ·<br>572标准规定的 | 限量要求以下。 |        |
|                                | 该部件所有均质<br>oncentration c | 贡材料中的含量<br>of the hazardo | 均在GB/T 265<br>us substance ii | ·<br>572标准规定的 | 限量要求以下。 |        |

# Page 2 of 2